

**IGBT** 

# SGH10N120RUFD

# Short Circuit Rated IGBT

# **General Description**

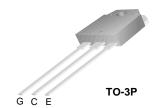
Fairchild's RUFD series of Insulated Gate Bipolar Transistors (IGBTs) provides low conduction and switching losses as well as short circuit ruggedness. The RUFD series is designed for applications such as motor control, uninterrupted power supplies (UPS) and general inverters where short circuit ruggedness is a required feature.

#### **Features**

- Short circuit rated 10 $\mu$ s @ T<sub>C</sub> = 100°C, V<sub>GE</sub> = 15V
- · High speed switching
- Low saturation voltage :  $V_{CE(sat)} = 2.3 \text{ V} @ I_C = 10 \text{A}$
- · High input impedance
- CO-PAK, IGBT with FRD :  $t_{rr} = 65$ ns (typ.)

# **Applications**

AC & DC motor controls, general purpose inverters, robotics, and servo controls.





# **Absolute Maximum Ratings** $T_C = 25^{\circ}C$ unless otherwise noted

| Symbol              | Description   |                          | SGH10N120RUFD | Units |
|---------------------|---|--------------------------|---------------|-------|
| V <sub>CES</sub>    | Collector-Emitter Voltage   |                          | 1200          | V     |
| V <sub>GES</sub>    | Gate-Emitter Voltage  |                          | ± 25          | V     |
|                     | Collector Current   | @ T <sub>C</sub> = 25°C  | 16            | А     |
| IC                  | Collector Current   | @ T <sub>C</sub> = 100°C | 10            | Α     |
| I <sub>CM (1)</sub> | Pulsed Collector Current  |                          | 30            | А     |
| I <sub>F</sub>      | Diode Continuous Forward Current  | @ T <sub>C</sub> = 100°C | 10            | Α     |
| I <sub>FM</sub>     | Diode Maximum Forward Current   |                          | 60            | Α     |
| T <sub>SC</sub>     | Short Circuit Withstand Time  | @ T <sub>C</sub> = 100°C | 10            | μs    |
| P <sub>D</sub>      | Maximum Power Dissipation   | @ T <sub>C</sub> = 25°C  | 125           | W     |
|                     | Maximum Power Dissipation   | @ T <sub>C</sub> = 100°C | 50            | W     |
| TJ                  | Operating Junction Temperature  |                          | -55 to +150   | °C    |
| T <sub>stg</sub>    | Storage Temperature Range   | -55 to +150              | °C            |       |
| T <sub>L</sub>      | Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds |                          | 300           | °C    |

#### Notes:

(1) Repetitive rating : Pulse width limited by max. junction temperature

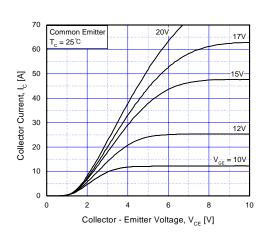
#### **Thermal Characteristics**

| Symbol                 | Parameter                               | Тур. | Max. | Units |
|------------------------|---|------|------|-------|
| $R_{\theta JC}(IGBT)$  | Thermal Resistance, Junction-to-Case    |      | 1.0  | °C/W  |
| $R_{\theta JC}(DIODE)$ | Thermal Resistance, Junction-to-Case    |      | 1.5  | °C/W  |
| $R_{\theta JA}$        | Thermal Resistance, Junction-to-Ambient |      | 40   | °C/W  |

| Symbol                          | Parameter                                    | Test Conditions  | Min. | Тур.     | Max.  | Units |
|---------------------------------|--|--|------|----------|-------|-------|
| Off Chai                        | racteristics                                 |  |      |          |       |       |
| BV <sub>CES</sub>               | Collector-Emitter Breakdown Voltage          | $V_{GE} = 0V$ , $I_C = 1mA$  | 1200 |          |       | V     |
| $\Delta B_{VCES}/$ $\Delta T_J$ | Temperature Coefficient of Breakdown Voltage | $V_{GE} = 0V$ , $I_C = 1mA$  |      | 0.6      |       | V/°C  |
| I <sub>CES</sub>                | Collector Cut-Off Current                    | $V_{CE} = V_{CES}$ , $V_{GE} = 0V$   |      |          | 1     | mA    |
| I <sub>GES</sub>                | G-E Leakage Current                          | $V_{GE} = V_{GES}, V_{CE} = 0V$  |      |          | ± 100 | nA    |
| On Char                         | acteristics                                  |  |      |          |       |       |
| V <sub>GE(th)</sub>             | G-E Threshold Voltage                        | $I_C = 10$ mA, $V_{CE} = V_{GE}$   | 3.5  | 5.5      | 7.5   | V     |
|                                 | Collector to Emitter                         | $I_C = 10 \text{ A},  V_{GE} = V_{GE}$                                     |      | 2.3      | 3.0   | V     |
| $V_{CE(sat)}$                   | Saturation Voltage                           | $I_C = 16A$ , $V_{GE} = 15V$   |      | 2.8      |       | V     |
|                                 |  | C - 7 GL   |      |          |       |       |
|                                 | Characteristics                              |  |      |          | T     |       |
| C <sub>ies</sub>                | Input Capacitance                            | $V_{CE} = 30V_{V_{GE}} = 0V_{V_{GE}}$                                      |      | 950      |       | pF    |
| C <sub>oes</sub>                | Output Capacitance                           | - f = 1MHz   |      | 75<br>30 |       | pF    |
| C <sub>res</sub>                | Reverse Transfer Capacitance                 | <u> </u>   |      | 00       |       | pF    |
|                                 | ng Characteristics                           |  |      | 20       |       |       |
| t <sub>d(on)</sub>              | Turn-On Delay Time                           | 4  |      | 20       |       | ns    |
| t <sub>r</sub>                  | Rise Time                                    |  |      | 60       |       | ns    |
| t <sub>d(off)</sub>             | Turn-Off Delay Time                          | $V_{CC} = 600 \text{ V}, I_C = 10\text{A},$                                |      | 60       | 110   | ns    |
| t <sub>f</sub>                  | Fall Time                                    | $R_G = 25\Omega$ , $V_{GE} = 15V$ ,  |      | 150      | 300   | ns    |
| E <sub>on</sub>                 | Turn-On Switching Loss                       | Inductive Load, T <sub>C</sub> = 25°C                                      |      | 0.65     |       | mJ    |
| E <sub>off</sub>                | Turn-Off Switching Loss                      |  |      | 0.65     |       | mJ    |
| E <sub>ts</sub>                 | Total Switching Loss                         |  |      | 1.3      | 1.85  | mJ    |
| t <sub>d(on)</sub>              | Turn-On Delay Time                           |  |      | 20       |       | ns    |
| t <sub>r</sub>                  | Rise Time                                    |  |      | 70       |       | ns    |
| t <sub>d(off)</sub>             | Turn-Off Delay Time                          | $V_{CC} = 600 \text{ V}, I_{C} = 10\text{A},$                              |      | 80       | 150   | ns    |
| t <sub>f</sub>                  | Fall Time                                    | $R_G = 25\Omega, V_{GE} = 15V,$  |      | 200      | 400   | ns    |
| E <sub>on</sub>                 | Turn-On Switching Loss                       | Inductive Load, T <sub>C</sub> = 125°C                                     |      | 0.75     |       | mJ    |
| E <sub>off</sub>                | Turn-Off Switching Loss                      |  |      | 1.00     |       | mJ    |
| E <sub>ts</sub>                 | Total Switching Loss                         |  |      | 1.75     | 2.54  | mJ    |
| T <sub>sc</sub>                 | Short Circuit Withstand Time                 | V <sub>CC</sub> = 600 V, V <sub>GE</sub> = 15V<br>@ T <sub>C</sub> = 100°C | 10   |          |       | μs    |
| $Q_g$                           | Total Gate Charge                            |  |      | 50       | 75    | nC    |
| $Q_{ge}$                        | Gate-Emitter Charge                          | $V_{CE} = 600 \text{ V}, I_{C} = 10\text{A},$<br>$V_{GE} = 15\text{V}$     |      | 6        | 9     | nC    |
| Q <sub>qc</sub>                 | Gate-Collector Charge                        | VGE = 13V  |      | 25       | 40    | nC    |
|                                 | Internal Emitter Inductance                  | Measured 5mm from PKG  |      | 14       |       | nH    |

# Electrical Characteristics of DIODE $T_C = 25^{\circ}C$ unless otherwise noted

| Symbol          | Parameter                     | Test Conditions                          |                        | Min. | Тур. | Max. | Units |
|-----------------|-------------------------------|--|------------------------|------|------|------|-------|
| V               | Diodo Forward Voltago         | I <sub>E</sub> = 10A                     | $T_C = 25^{\circ}C$    |      | 2.9  | 3.5  | \/    |
| $V_{FM}$        | Diode Forward Voltage         | I <sub>F</sub> = TUA                     | $T_C = 100^{\circ}C$   |      | 2.7  |      | V     |
|                 | Diode Reverse Recovery Time   | I <sub>F</sub> = 10A<br>dI/dt = 200 A/μs | $T_C = 25^{\circ}C$    |      | 65   | 100  | ns    |
| t <sub>rr</sub> | Diode Reverse Recovery Time   |  | T <sub>C</sub> = 100°C |      | 90   |      |       |
|                 | Diode Peak Reverse Recovery   |  | $T_C = 25^{\circ}C$    |      | 6.0  | 8.0  | Α     |
| ¹rr             | Current                       |  | T <sub>C</sub> = 100°C |      | 7.5  |      | A     |
| Q <sub>rr</sub> | Diode Reverse Recovery Charge |  | $T_C = 25^{\circ}C$    |      | 195  | 400  | nC    |
|                 |                               |  | T <sub>C</sub> = 100°C | 1    | 300  |      | 110   |



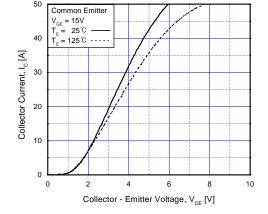
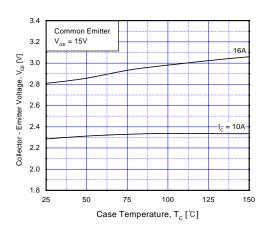


Fig 1. Typical Output Characteristics

Fig 2. Typical Saturation Voltage Characteristics



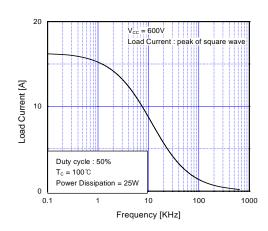
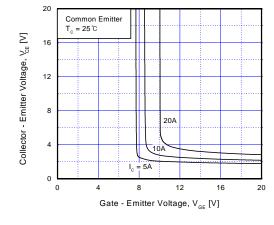


Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

Fig 4. Load Current vs. Frequency



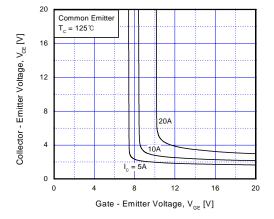
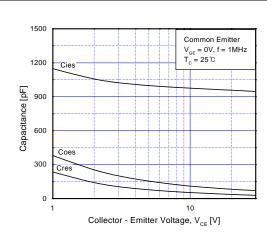


Fig 5. Saturation Voltage vs.  $V_{\text{GE}}$ 

Fig 6. Saturation Voltage vs.  $V_{\text{GE}}$ 

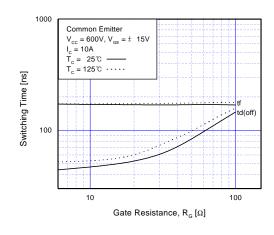
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Common Emitter  $V_{\rm CC}=600{\rm V}, V_{\rm CE}=\pm 15{\rm V}$   $V_{\rm CC}=600{\rm V}, V_{\rm CE}=\pm 15{\rm V}$   $V_{\rm CC}=10{\rm A}$   $V_{\rm CC}=125{\rm C}$   $V_{\rm CC}=1$ 

Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs.
Gate Resistance



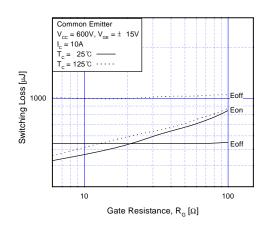
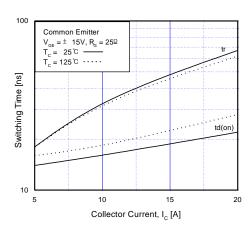


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance



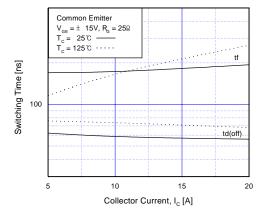
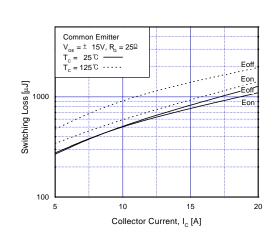


Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs. Collector Current



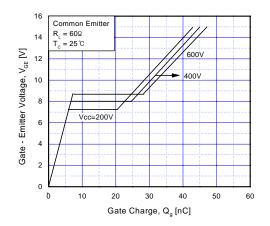
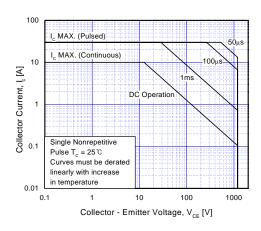


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



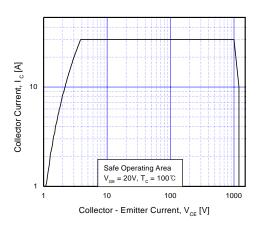


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA

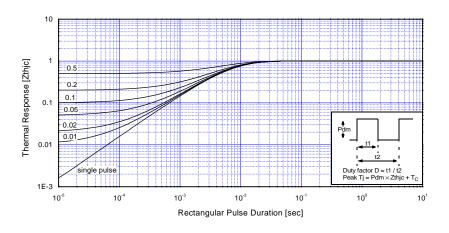
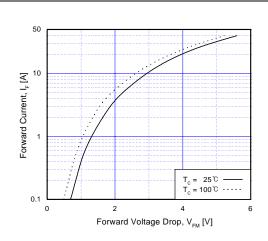


Fig 17. Transient Thermal Impedance of IGBT



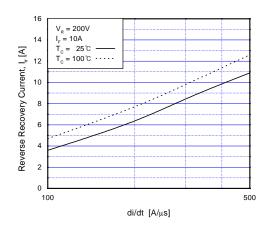
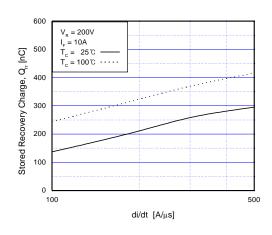


Fig 18. Forward Characteristics

Fig 19. Reverse Recovery Current



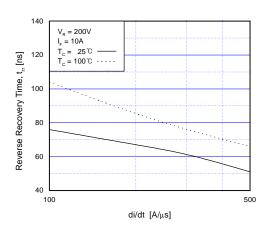
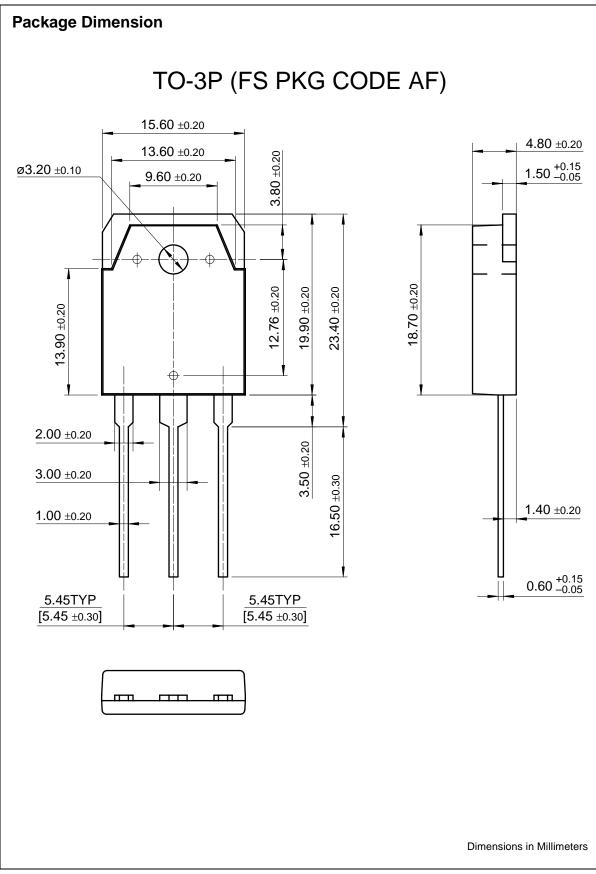


Fig 20. Stored Charge

Fig 21. Reverse Recovery Time



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